

-30V P-Channel Enhancement Mode MOSFET

DESCRIPTION

The SMC3407 is the P-Channel logic enhancement mode power field effect transistor is produced using high cell density. advanced trench technology to provide excellent $R_{DS(ON)}$. This device is suitable for use as a load switch or in applications.

SMC3407S-TRG ROHS Compliant This is Halogen Free

FEATURE

- ◆ $-30V/-4.3A, R_{DS(ON)} = 44m\Omega (typ.) @ V_{GS} = -10V$
- ◆ $-30V/-3.0A, R_{DS(ON)} = 70m\Omega (typ.) @ V_{GS} = -4.5V$
- ◆ Super high density cell design for extremely low $R_{DS(ON)}$
- ◆ Exceptional on-resistance and Maximum DC current capability

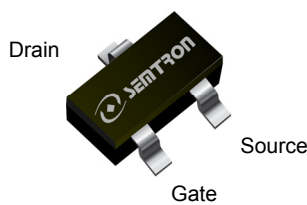
APPLICATIONS

- ◆ Cellular/Portable
- ◆ Load Switch

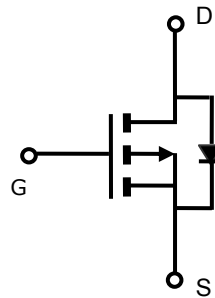


P-Channel Enhancement Mode MOSFET

PIN CONFIGURATION



SOT-23L
Top View



PART NUMBER INFORMATION

<p>SMC 3407 S – TR G</p> <p>a b c d e</p>	<p>a : Company name. b : Product Serial number. c : Package code d : Handling code e : Green produce code</p>
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ORDERING INFORMATION

Part Number	Package Code	Handling Code	Shipping
SMC3407S-TRG	S : SOT-23L	TR : Tape&Reel	3K/Reel

- ※ Year Code : 0 ~ 9, 2010 : 0
- ※ Week Code : A(1~2) ~ Z(53~54)
- ※ SOT-23L : Only available in tape and reel packaging.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C Unless otherwise noted)

Symbol	Parameter	Typical	Unit	
V _{DSS}	Drain-Source Voltage	-30	V	
V _{GSS}	Gate-Source Voltage	±20	V	
I _D	Continuous Drain Current (T _C =25°C) ^A	V _{GS} =-10V	-4.3	A
	Continuous Drain Current (T _C =70°C) ^A		-3.5	A
I _{DM}	Pulsed Drain Current ^B	-20	A	
P _D	Power Dissipation	T _A =25°C	1.5	W
		T _A =70°C	0.9	
T _J	Operation Junction Temperature	-55 to 150	°C	
T _{STG}	Storage Temperature Range	-55 to 150	°C	

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.
 Absolute maximum ratings are stress ratings only and functional device operation is not implied.

THERMAL DATA

Symbol	Parameter	Typ	Max	Unit	
R _{θJA}	Thermal Resistance-Junction to Ambient	Steady-State	-	125	°C/W
R _{θJL}	Thermal Resistance Junction to Lead	Steady-State	-	80	°C/W

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ Unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Parameters						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-30			V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1.0		-2.0	V
I_{GSS}	Gate Leakage Current	$V_{DS}=0V, V_{GS}=\pm 8V$			± 100	μA
I_{DSS}	Zero Gate Voltage, Drain-Source Leakage Current	$V_{DS}=-24V, V_{GS}=0V$ $T_J=25^\circ\text{C}$			-1	μA
		$V_{DS}=-24V, V_{GS}=0V$ $T_J=55^\circ\text{C}$			-5	
$R_{DS(ON)}$	Drain-source On-Resistance ^B	$V_{GS}=-10V, I_D=-4.3A$ $V_{GS}=-4.5V, I_D=-3.0A$		44 70	54 85	m Ω
G_{fs}	Forward Transconductance	$V_{DS}=-5V, I_D=-3.0A$		11		S
Source-Drain Diode						
V_{SD}	Diode Forward Voltage	$I_S=-1.0A, V_{GS}=0V$		-0.7	-1.0	V
I_S	Continuous Source Current ^{AD}				-3.5	A
Dynamic Parameters						
$Q_g (-4.5V)$	Total Gate Charge	$V_{DS}=-15V$		6.5		nC
Q_{gs}	Gate-Source Charge	$V_{GS}=-4.5V$		2.4		
Q_{gd}	Gate-Drain Charge	$I_D=-3.0A$		2.0		
C_{iss}	Input Capacitance	$V_{DS}=-15V$		592		pF
C_{oss}	Output Capacitance	$V_{GS}=0V$		102		
C_{rss}	Reverse Transfer Capacitance	$f=1\text{MHz}$		81		
$t_{d(on)}$	Turn-On Time	$V_{DD}=-15V$ $I_D=-3A$		2.9		nS
t_r				8.4		
$t_{d(off)}$	Turn-Off Time	$V_{GEN}=-4.5V$ $R_G=3.3\Omega$		40		μA
t_f				6.2		

Note:

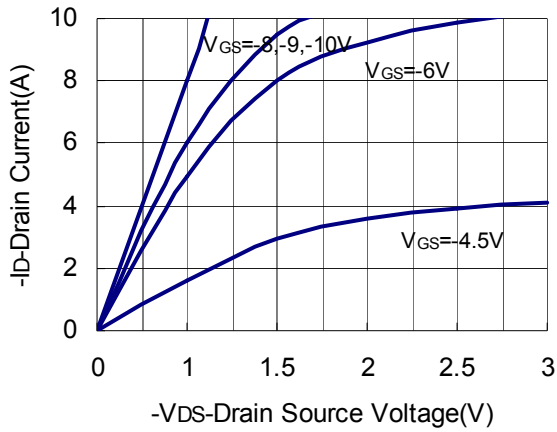
- The value of $R_{\theta JA}$ is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$.
- The data tested by pulsed, pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
- The EAS data shows Max. rating. The test condition is $V_{DD}=-25V, V_{GS}=-10V, L=0.1\text{mH}$.
- The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

The products and product specifications contained herein are subject to change without notice to improve performance characteristics. Consult us, or our representatives before use, to confirm that the information in this datasheet is up to date

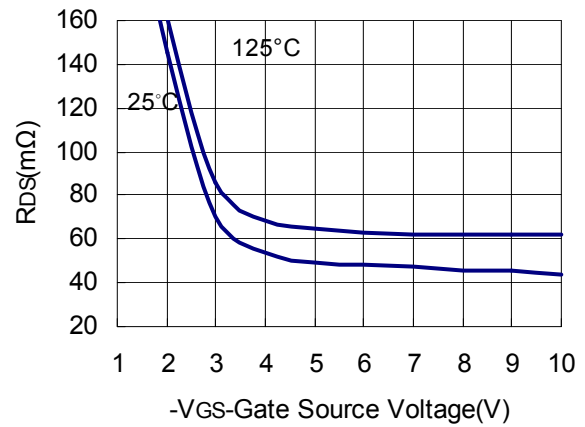
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TYPICAL CHARACTERISTICS (25°C Unless Note)

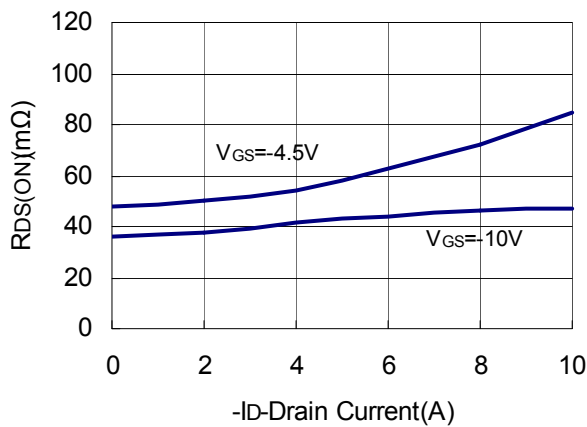
Output Characteristics



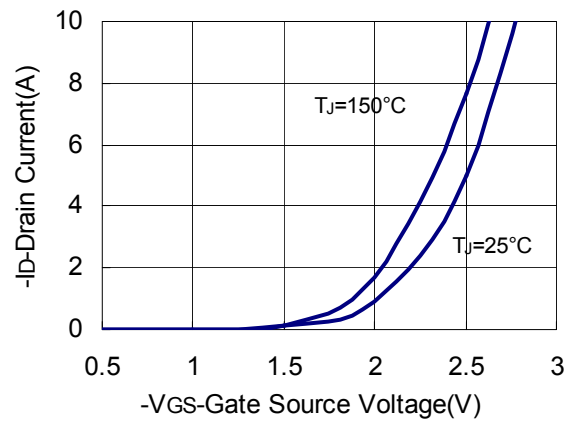
Drain-Source On Resistance



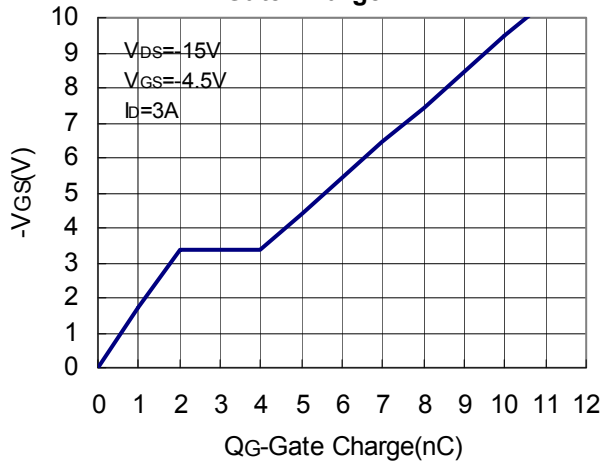
Drain Source On Resistance



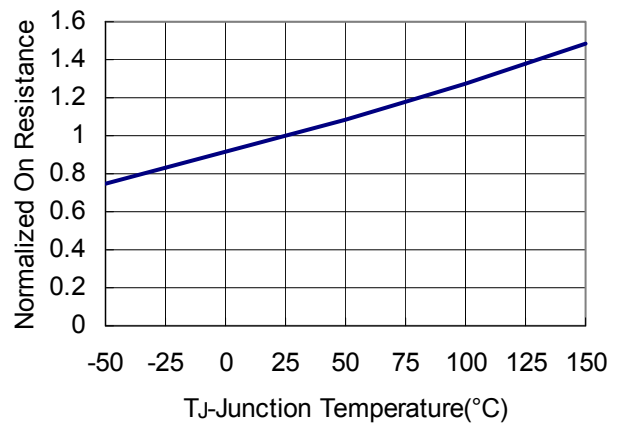
Transfer Characteristics



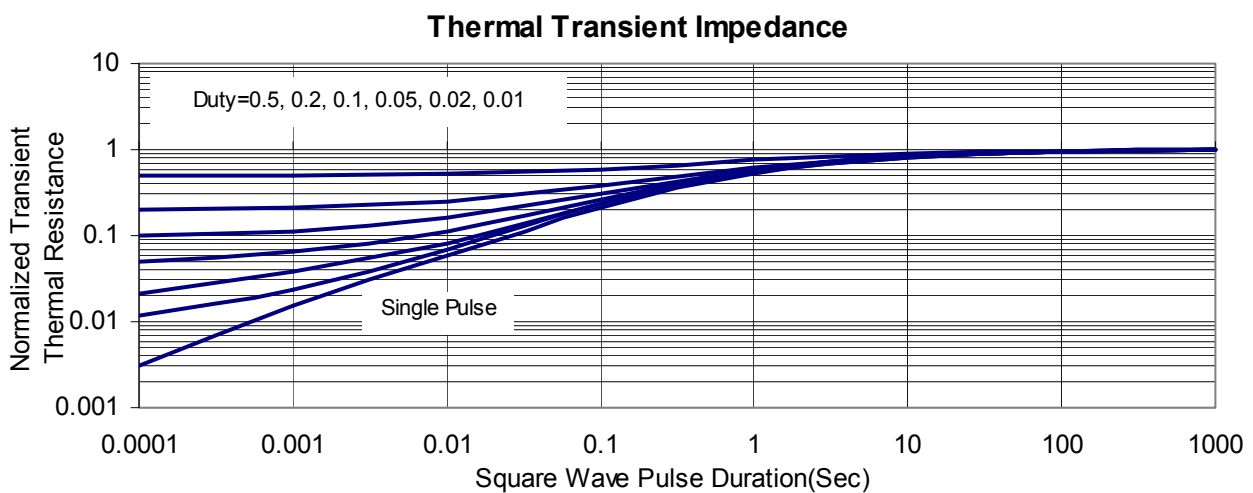
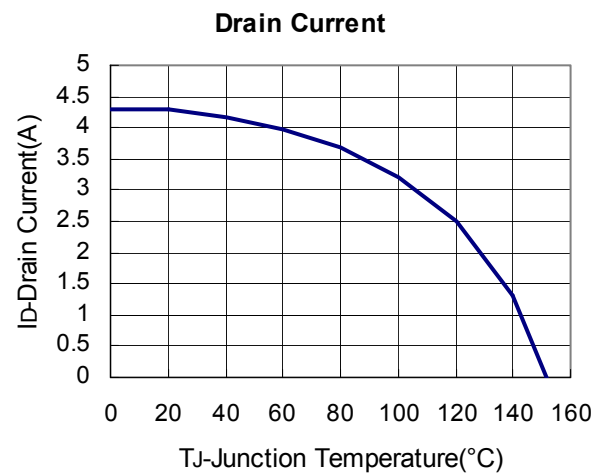
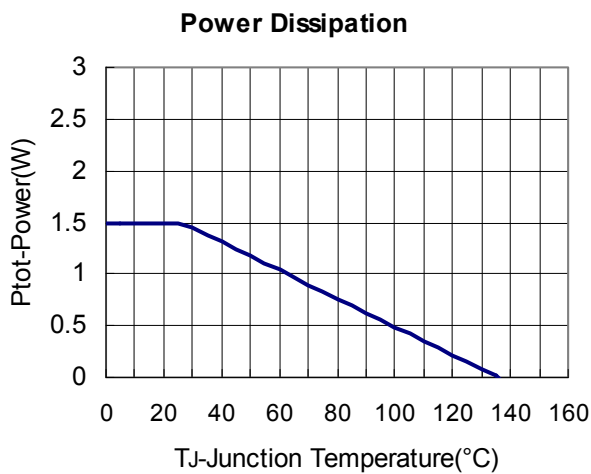
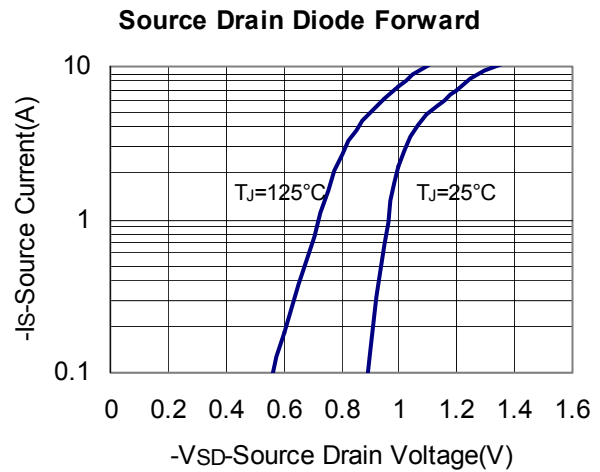
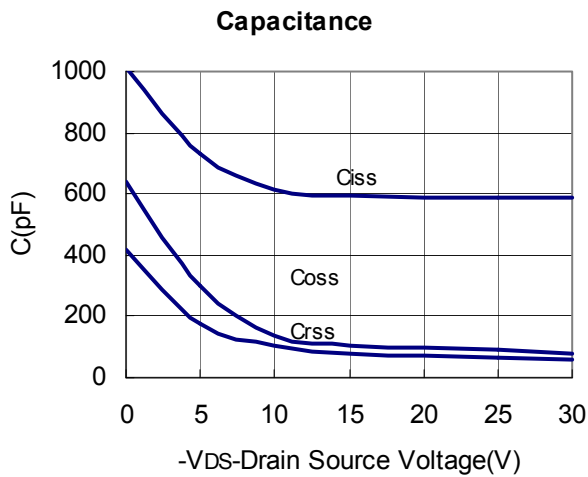
Gate Charge



Drain Source On Resistance



TYPICAL CHARACTERISTICS (25°C Unless Note)



SOT-23L PACKAGE DIMENSIONS

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950 BSC		0.037 BSC	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

SOT-23L PACKAGE OUTLINE DIMENSIONS

